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ISSUE CLASSIFICATION	
Class	Subclass

PATENT NUMBER

**U.S. UTILITY Patent Application**

O.I.P.E. <i>WJ</i>	PATENT DATE
SCANNED <i>KC Bk-3</i> Q.A. <i>TM</i>	

APPLICATION NO. 09/779812	CONT/PRIOR	CLASS <del>257</del> 435	SUBCLASS 612	ART UNIT <del>3811</del> 2812	EXAMINER Nguyen, Ha
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APPLICANTS  
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TITLE  
Lead-free solder structure and method for high fatigue life

FTO-223  
12/89

[illegible]

<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>	<b>DRAWINGS</b>			<b>CLAIMS ALLOWED</b>	
	Sheets Dwg.	Figs. Dwg.	Print Fig.	Total Claims	Print Claim for O.G.
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<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent. No. _____ _____ _____				<b>ISSUE FEE</b>	
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